

3.5x2.8 mm INFRARED EMITTING DIODE

Part Number: AA3528F3S

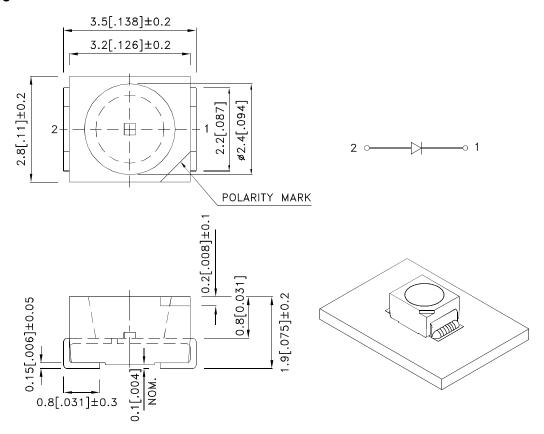
Features

- Mechanically and spectrally matched to the phototransistor.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

F3 Made with Gallium Arsenide Infrared Emitting diodes.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

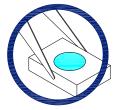
SPEC NO: DSAL0863 **REV NO: V.6A** DATE: APR/25/2015 PAGE: 1 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** ERP: 1201004680 DRAWN: Q.M.Chen

Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

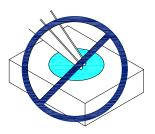
As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

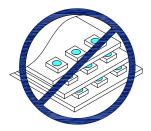


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

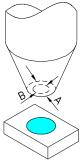




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

 SPEC NO: DSAL0863
 REV NO: V.6A
 DATE: APR/25/2015
 PAGE: 2 OF 6

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: Q.M.Chen
 ERP: 1201004680

Selection Guide

Part No.	Dice	Lens Type	Po (mW/sr) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
AA3528F3S	F3 (GaAs)	Water Clear	1.6	4	120°
			*1.2	*2.5	

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Radiant Intensity / luminous flux: +/-15%.

 * Radiant Intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Parameter	P/N	Symbol	Тур.	Max.	Units	Test Conditions	
Forward Voltage [1]	F3	VF	1.2	1.6	V	IF=20mA	
Reverse Current	F3	lR		10	uA	V _R = 5V	
Capacitance	F3	С	90		pF	VF=0V;f=1MHz	
Peak Spectral Wavelength	F3	λР	940		nm	IF=20mA	
Spectral Bandwidth	F3	Δλ1/2	50		nm	IF=20mA	

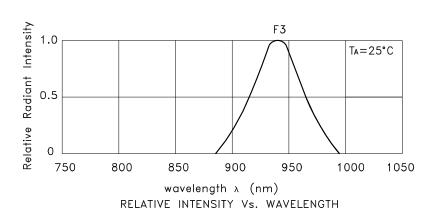
- 1. Forward Voltage: + / -0.1V.
- 2. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 3. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

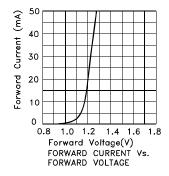
Parameter	Symbol	F3	Units
Power dissipation	PD	80	mW
DC Forward Current	lF	50	mA
Peak Forward Current [1]	iFS	1.2	А
Reverse Voltage	VR	5	V
Operating Temperature	Та	-40 To +85	°C
Storage Temperature	Тѕтс	-40 To +85	°C

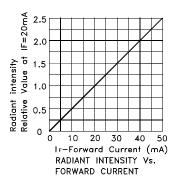
1. 1 / 100 Duty Cycle, 10µs Pulse Width.

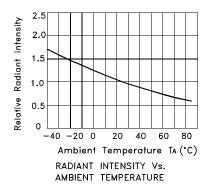
SPEC NO: DSAL0863 **REV NO: V.6A** DATE: APR/25/2015 PAGE: 3 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** ERP: 1201004680 DRAWN: Q.M.Chen

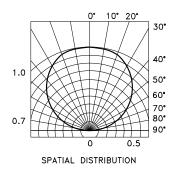


AA3528F3S







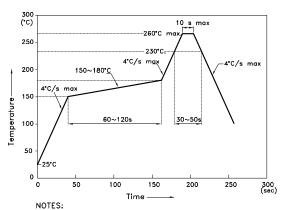


SPEC NO: DSAL0863 REV NO: V.6A DATE: APR/25/2015 PAGE: 4 OF 6
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Q.M.Chen ERP: 1201004680

AA3528F3S

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

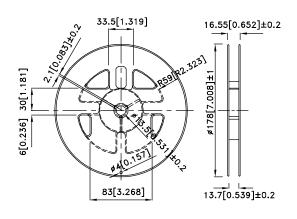
 3.Number of reflow process shall be 2 times or less.

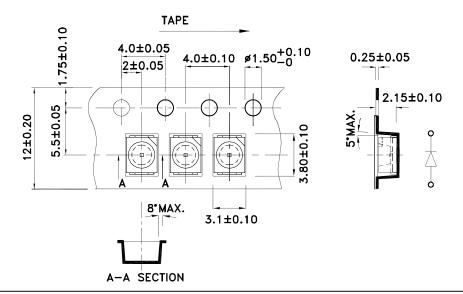
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

1.5 1.5 1.6

Tape Specifications (Units: mm)

Reel Dimension



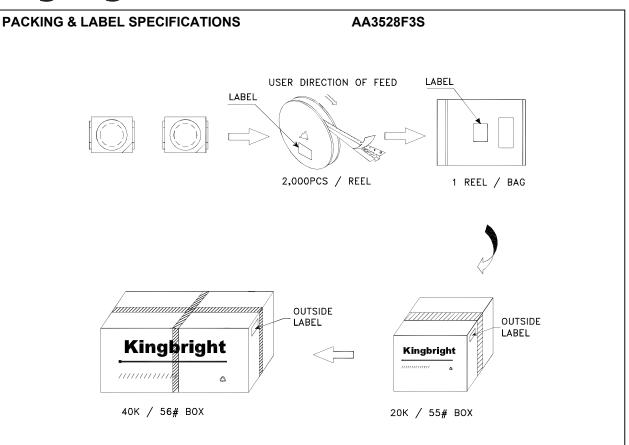


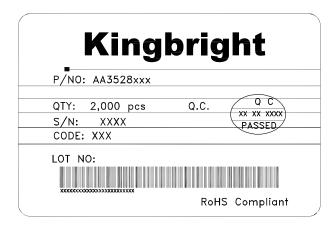
SPEC NO: DSAL0863 **APPROVED: WYNEC**

REV NO: V.6A CHECKED: Allen Liu **DATE: APR/25/2015** DRAWN: Q.M.Chen

PAGE: 5 OF 6 ERP: 1201004680







Terms and conditions for the usage of this document

- 1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- 4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
- 5. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
- 6. All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes

 SPEC NO: DSAL0863
 REV NO: V.6A
 DATE: APR/25/2015
 PAGE: 6 OF 6

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: Q.M.Chen
 ERP: 1201004680